

PFM Asynchronous Step-up DC to DC Converter (100mA)
Features

- Low start-up voltage: 0.7V (Typ.), 0.9V (Max.)
- High efficiency: 85% (Typ.), $V_{OUT} \geq 2.7V$
- High output voltage accuracy: $\pm 2.5\%$
- Output voltage: 1.8V, 2.2V, 2.7V, 3.0V, 3.3V, 3.7V, 5.0V
- Output current up to 100mA
- Ultra low supply current I_{DD2} : 4 μ A (Typ.)
- Low ripple and low noise
- Low shutdown current: 0.5 μ A (Typ.)
- TO92, SOT89, SOT23 and SOT23-5 package

Applications

- Palmtops/PDAs
- Portable communicators/Smartphones
- Cameras/Camcorders
- Battery-powered equipment

General Description

The HT77xx series is a set of PFM step-up DC/DC converter with high efficiency and low ripple. The series features extremely low start-up voltage and high output voltage accuracy. They require only three external components to provide a fixed output voltage of 1.8V, 2.2V, 2.7V, 3.0V, 3.3V, 3.7V or 5.0V. CMOS technology ensures ultra low supply current and makes them ideal for battery-operated applications powered from one or more cells.

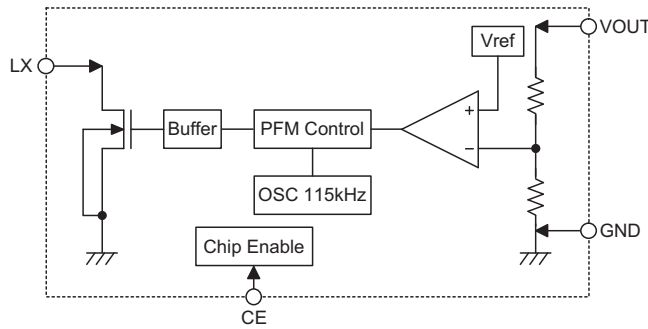
The HT77xx consists of an oscillator, a PFM control circuit, a driver transistor, a reference voltage unit, and a high speed comparator. They employ pulse frequency modulation (PFM) for minimum supply current and ripple at light output loading. These devices are available in space saving TO92, SOT89, SOT23 and SOT23-5 packages. For SOT23-5 package, it also build-in a chip enable function to reduce power consumption during shutdown mode.

Selection Table

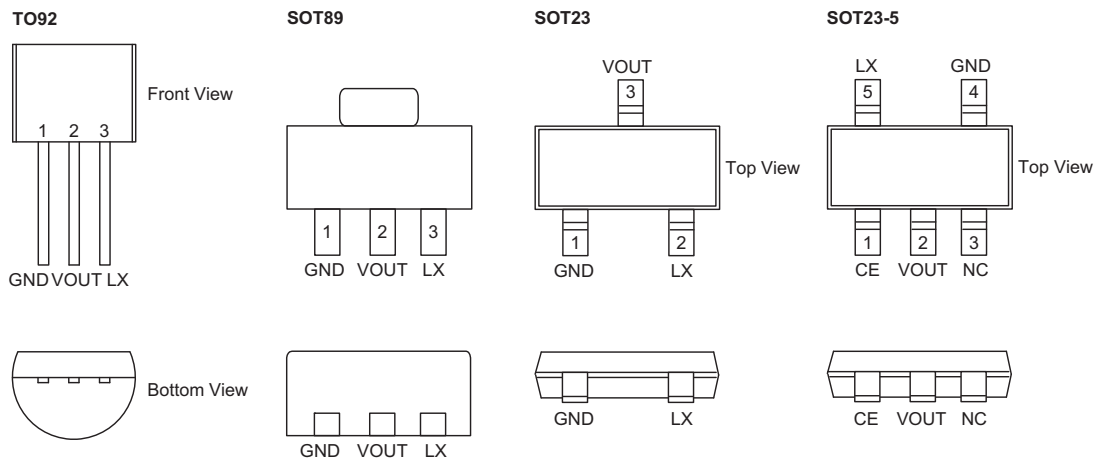
Part No.	Output Voltage	Package	Marking
HT7718	1.8V	TO92 SOT89 SOT23 SOT23-5	HT77xx (for TO92) HT77xx (for SOT89) 77xx (for SOT23) 77xx (for SOT23-5)
HT7722	2.2V		
HT7727	2.7V		
HT7730	3.0V		
HT7733	3.3V		
HT7737	3.7V		
HT7750	5.0V		

Note: "XX" stands for output voltages.

Block Diagram



Pin Assignment



Pin Description

Pin No.				Pin Name	Description
TO92	SOT89	SOT23	SOT23-5		
—	—	—	1	CE	Chip enable pin, high active
2	2	3	2	VOUT	DC/DC converter output monitoring pin
—	—	—	3	NC	No connection
1	1	1	4	GND	Ground pin
3	3	2	5	LX	Switching pin

Absolute Maximum Ratings

Supply Voltage $V_{SS}-0.3V$ to $V_{SS}+7V$ Storage Temperature $-50^{\circ}C$ to $125^{\circ}C$
 Operating Temperature $-40^{\circ}C$ to $85^{\circ}C$

Note: These are stress ratings only. Stresses exceeding the range specified under "Absolute Maximum Ratings" may cause substantial damage to the device. Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reliability.

Thermal Information

Symbol	Parameter	Package	Max.	Unit
θ_{JA}	Thermal Resistance (Junction to Ambient) (Assume no ambient airflow, no heat sink)	SOT89	300	°C/W
		TO92	300	°C/W
		SOT23	330	°C/W
		SOT23-5	320	°C/W
P_D	Power Dissipation	SOT89	0.33	W
		TO92	0.33	W
		SOT23	0.3	W
		SOT23-5	0.31	W

Note: P_D is measured at $T_a = 25^\circ\text{C}$

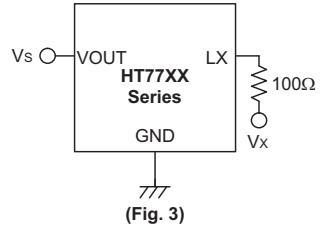
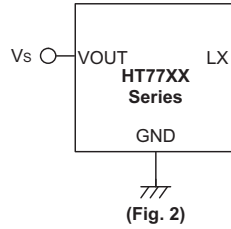
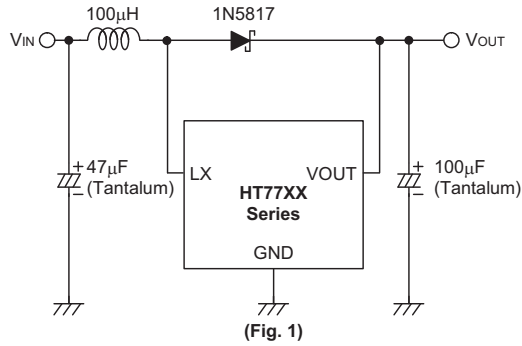
Electrical Characteristics

$V_{IN} = V_{OUT} \times 0.6$; $I_{OUT} = 10\text{mA}$; $T_a = 25^\circ\text{C}$ (Unless otherwise specified)

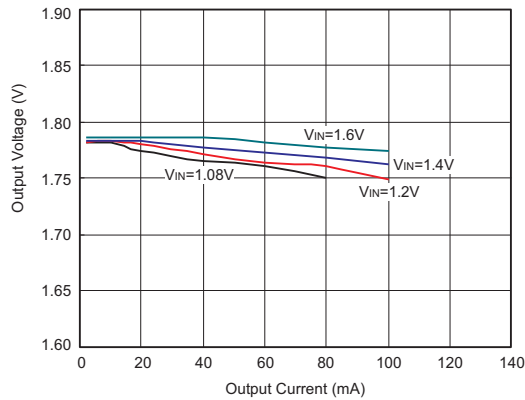
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit	
V_{IN}	Input Voltage	—	—	—	6	V	
ΔV_{OUT}	Output Voltage Tolerance	—	-2.5	—	2.5	%	
V_{START}	Start-up Voltage (Fig. 1)	$V_{IN}: 0 \rightarrow 2\text{V}$; $I_{OUT} = 1\text{mA}$	—	0.7	0.9	V	
V_{HOLD}	Minimum Hold-on Voltage (Fig. 1)	$V_{IN}: 2 \rightarrow 0\text{V}$; $I_{OUT} = 1\text{mA}$	—	—	0.7	V	
I_{IN}	No-load Input Current (Fig. 1)	$I_{OUT} = 0\text{mA}$	—	10	20	μA	
I_{DD1}	Supply Current 1 (Fig. 2)	$V_S = V_{OUT} \times 0.95$ Measured at V_{OUT} pin	$V_{OUT} = 1.8\text{V}$	—	35	50	μA
			$V_{OUT} = 2.2\text{V}$	—	37	55	
			$V_{OUT} = 2.7\text{V}$	—	40	60	
			$V_{OUT} = 3.0\text{V}$	—	45	68	
			$V_{OUT} = 3.3\text{V}$	—	55	81	
			$V_{OUT} = 3.7\text{V}$	—	64	85	
I_{DD2}	Supply Current 2 (Fig. 2)	$V_S = V_{OUT} + 0.5\text{V}$ Measured at V_{OUT} pin	—	4	7	μA	
			—	4	7		
I_{SHDN}	Shutdown Current	$CE = \text{GND}$	—	0.5	1	μA	
V_{IH}	CE High Threshold	—	2	—	—	V	
V_{IL}	CE Low Threshold	—	—	—	0.4	V	
I_{LEAK}	LX Leakage Current (Fig. 3)	$V_S = V_{OUT} + 0.5\text{V}$, $V_X = 6\text{V}$ Measured at the LX pin	—	—	0.9	μA	
f_{OSC}	Maximum Oscillator Frequency (Fig. 3)	$V_S = V_{OUT} \times 0.95$ Measured at LX pin	—	115	—	kHz	
D_{OSC}	Oscillator Duty Cycle (Fig. 3)	$V_S = V_{OUT} \times 0.95$ Measured at LX pin	65	75	85	%	
η	Efficiency	$V_{OUT} \leq 2.2\text{V}$	—	80	—	%	
		$V_{OUT} \geq 2.7\text{V}$	—	85	—		

Note: Absolute maximum ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but do not guarantee specific performance limits. The guaranteed specifications apply only for the test conditions listed.

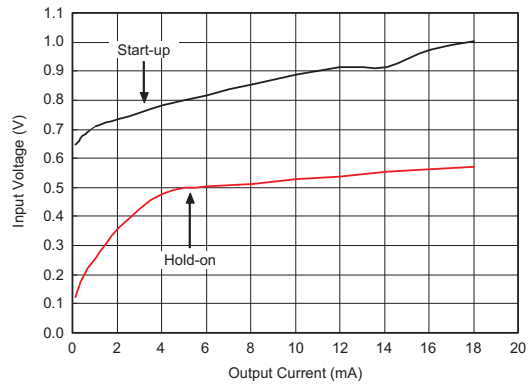
Test Circuit



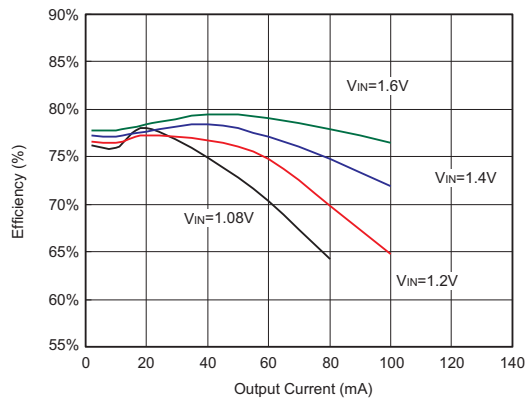
Typical Performance Characteristics



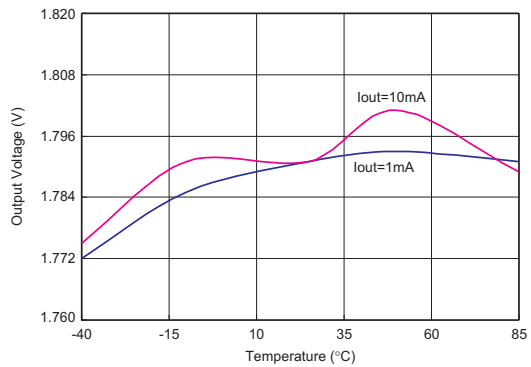
HT7718 Output Voltage v.s Output Current



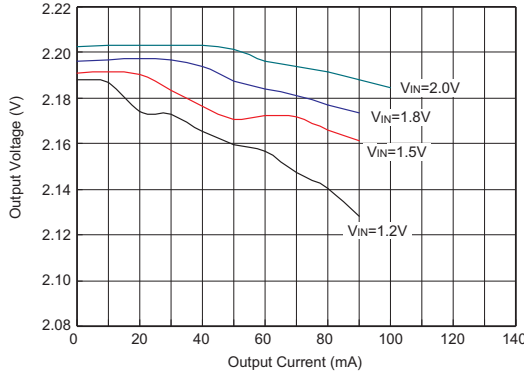
HT7718 Start-Up & Hold-On Voltage



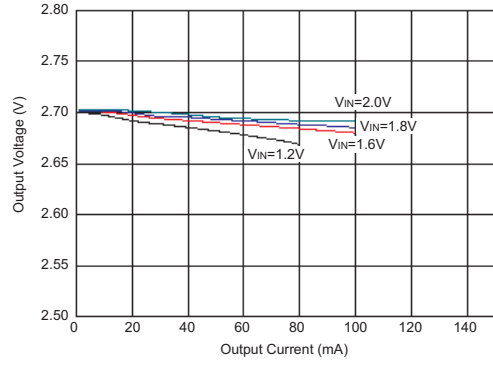
HT7718 Efficiency v.s Output Current



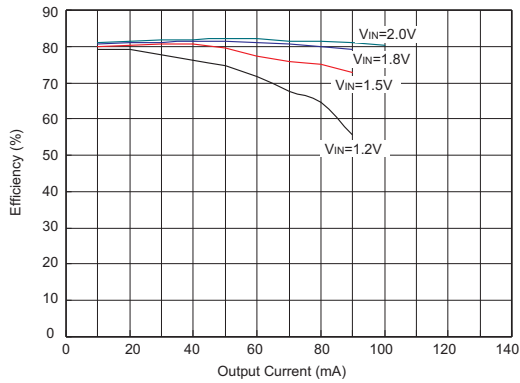
HT7718 Temperature v.s Output Voltage



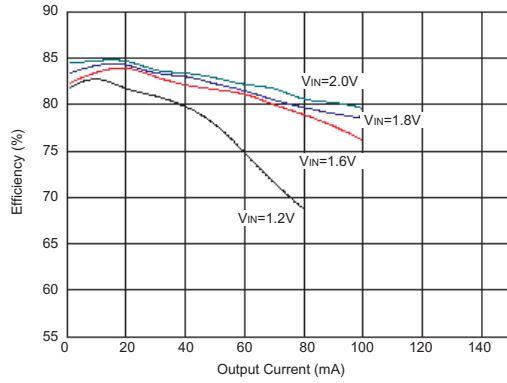
HT7722 Output Voltage v.s Output Current



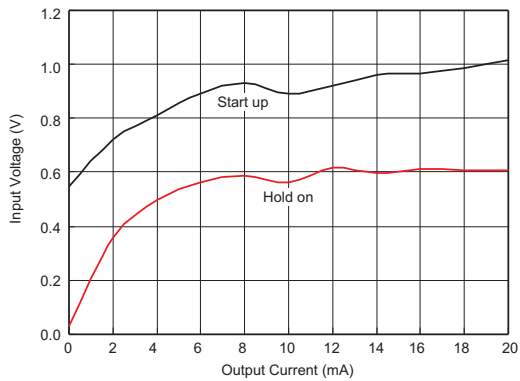
HT7727 Output Voltage v.s Output Current



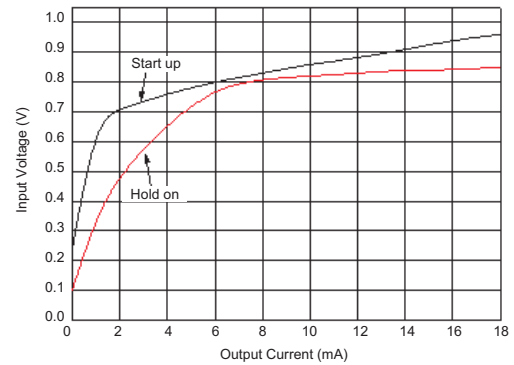
HT7722 Efficiency v.s Output Current



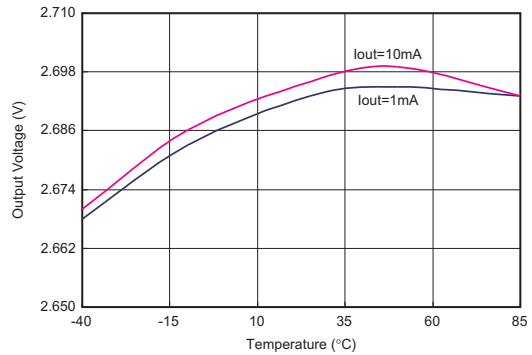
HT7727 Efficiency v.s Output Current



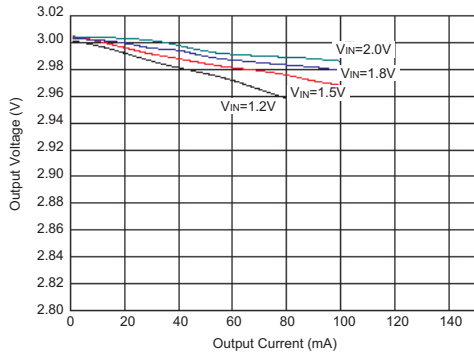
HT7722 Start-Up & Hold-On Voltage



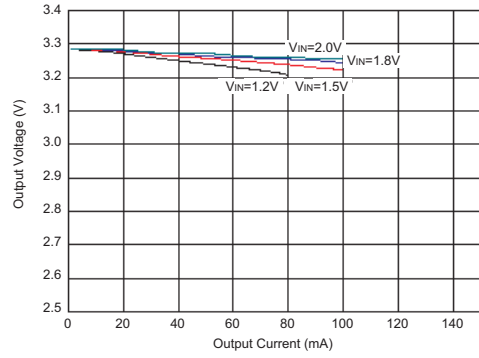
HT7727 Start-Up & Hold-On Voltage



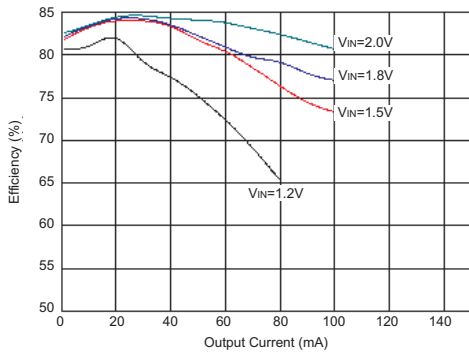
HT7727 Temperature v.s Output Voltage



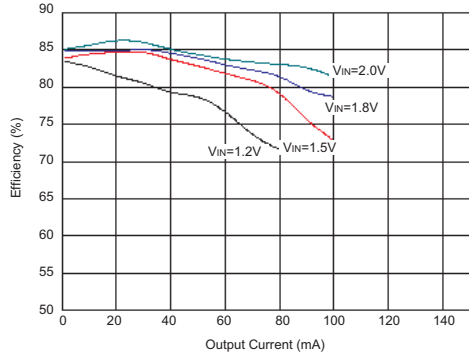
HT7730 Output Voltage v.s Output Current



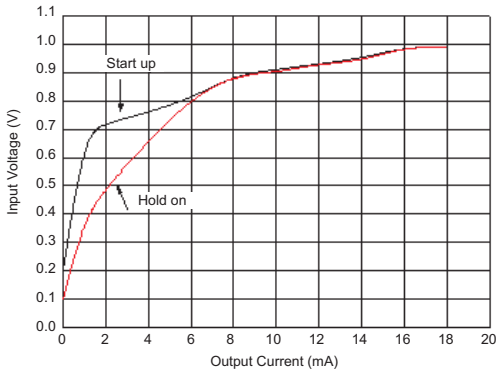
HT7733 Output Voltage v.s Output Current



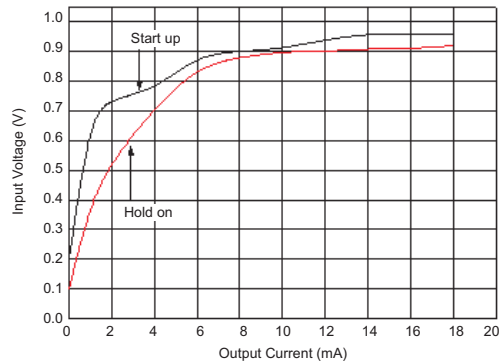
HT7730 Efficiency v.s Output Current



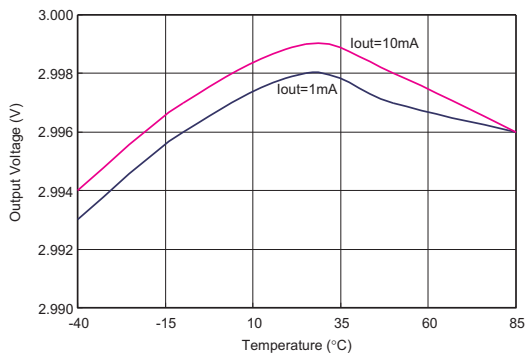
HT7733 Efficiency v.s Output Current



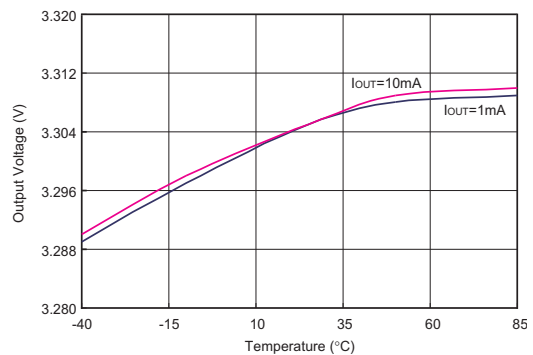
HT7730 Start-Up & Hold-On Voltage



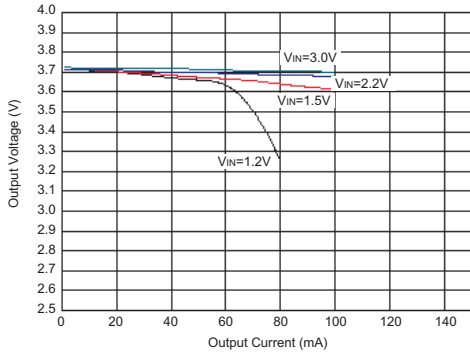
HT7733 Start-Up & Hold-On Voltage



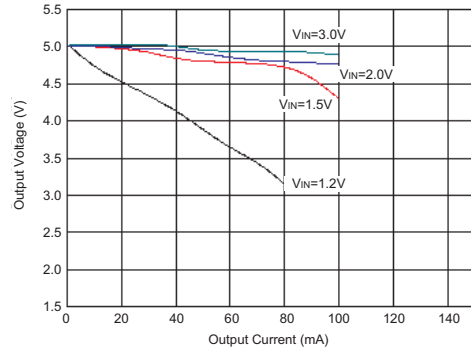
HT7730 Temperature v.s Output Voltage



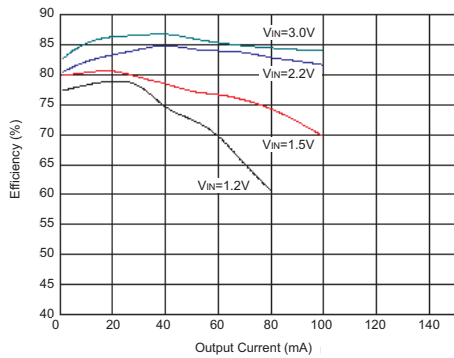
HT7733 Temperature v.s Output Voltage



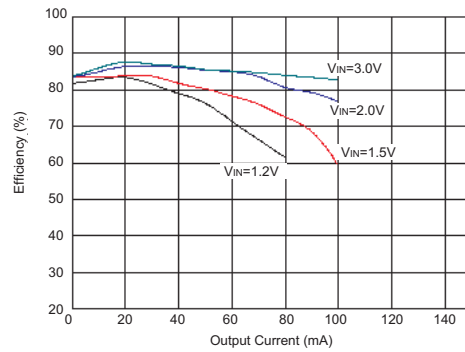
HT7737 Output Voltage v.s Output Current



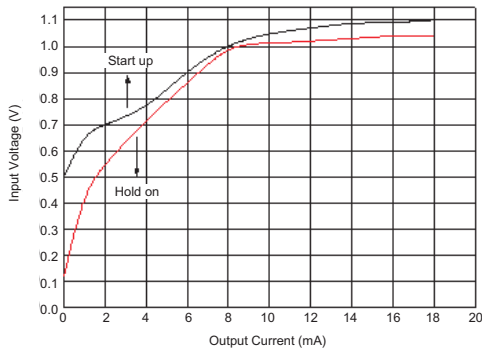
HT7750 Output Voltage v.s Output Current



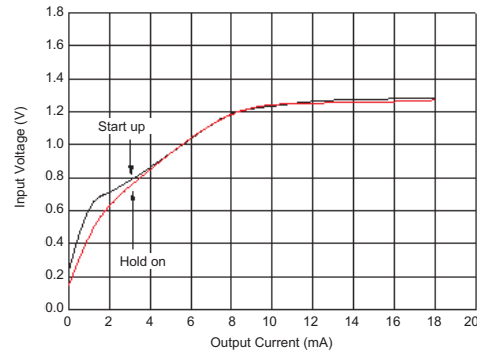
HT7737 Efficiency v.s Output Current



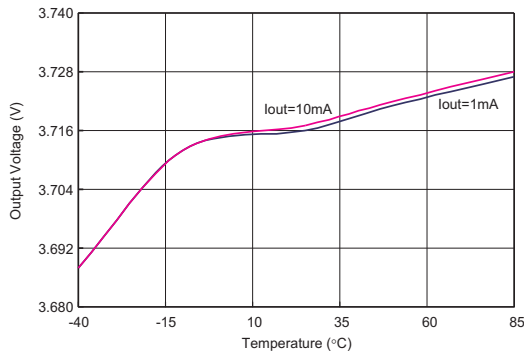
HT7750 Efficiency v.s Output Current



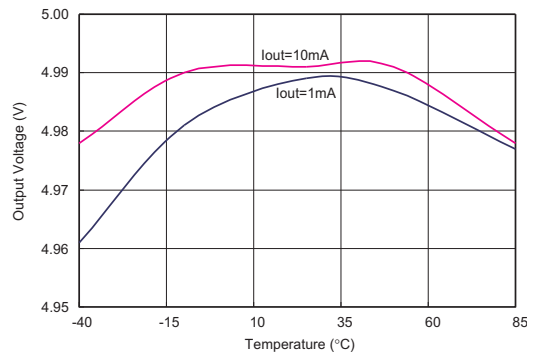
HT7737 Start-Up & Hold-On Voltage



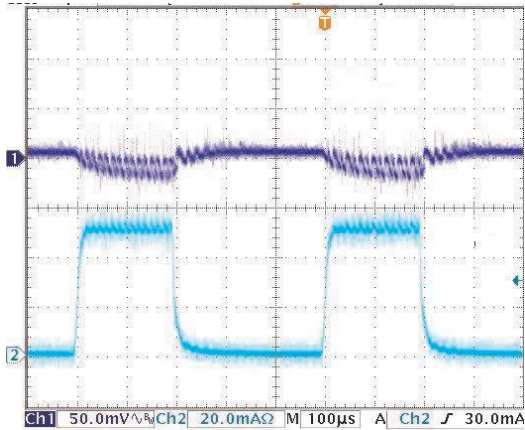
HT7750 Start-Up & Hold-On Voltage



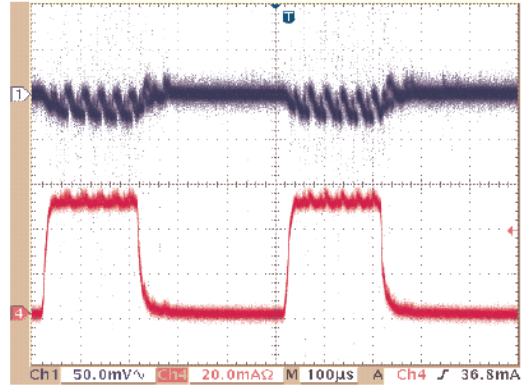
HT7737 Temperature v.s Output Voltage



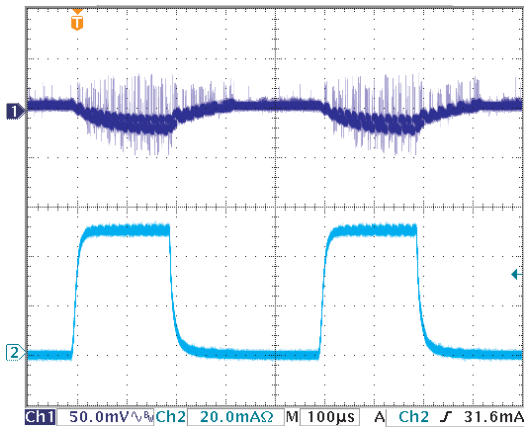
HT7750 Temperature v.s Output Voltage



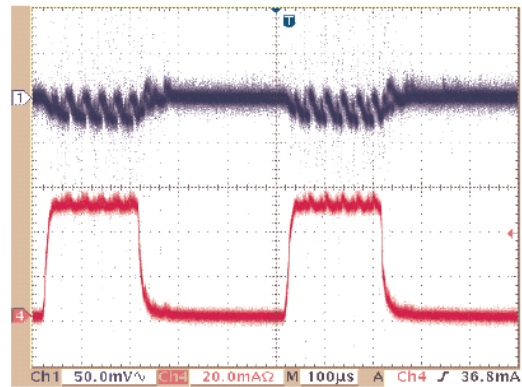
HT7718 Load Transient Response
($L=100\mu\text{H}$, $C_{\text{OUT}}=100\mu\text{F}$, $V_{\text{IN}}=1.08\text{V}$)



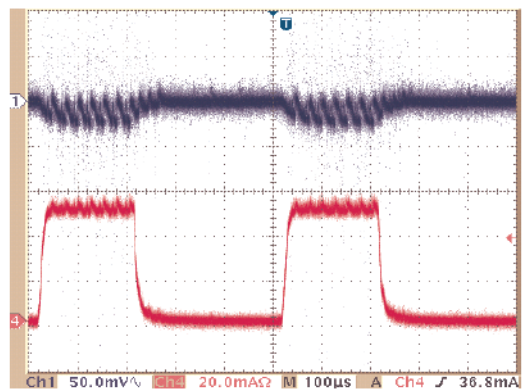
HT7730 Load Transient Response
($L=100\mu\text{H}$, $C_{\text{OUT}}=100\mu\text{F}$, $V_{\text{IN}}=1.8\text{V}$)



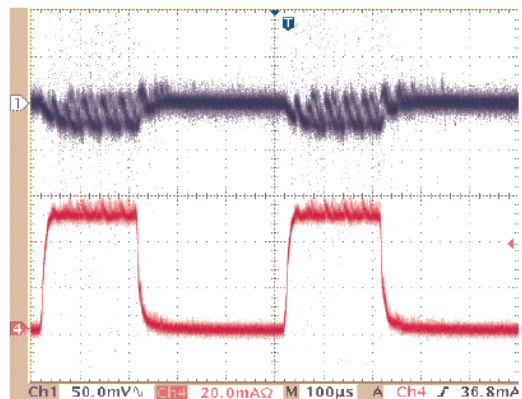
HT7722 Load Transient Response
($L=100\mu\text{H}$, $C_{\text{OUT}}=100\mu\text{F}$, $V_{\text{IN}}=1.08\text{V}$)



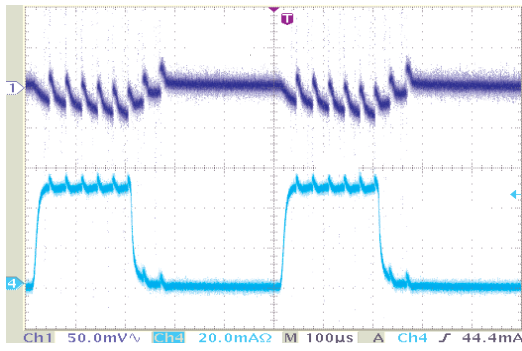
HT7733 Load Transient Response
($L=100\mu\text{H}$, $C_{\text{OUT}}=100\mu\text{F}$, $V_{\text{IN}}=1.98\text{V}$)



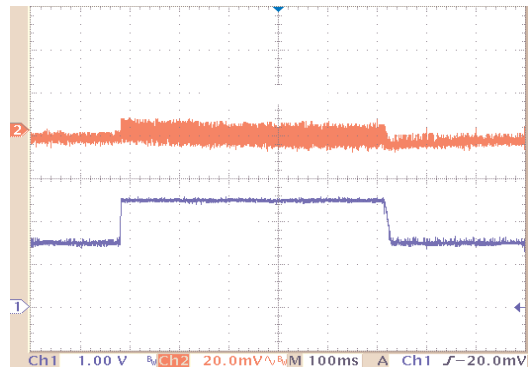
HT7727 Load Transient Response
($L=100\mu\text{H}$, $C_{\text{OUT}}=100\mu\text{F}$, $V_{\text{IN}}=1.62\text{V}$)



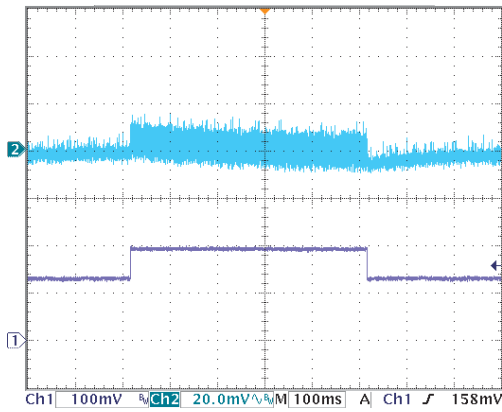
HT7737 Load Transient Response
($L=100\mu\text{H}$, $C_{\text{OUT}}=100\mu\text{F}$, $V_{\text{IN}}=2.22\text{V}$)



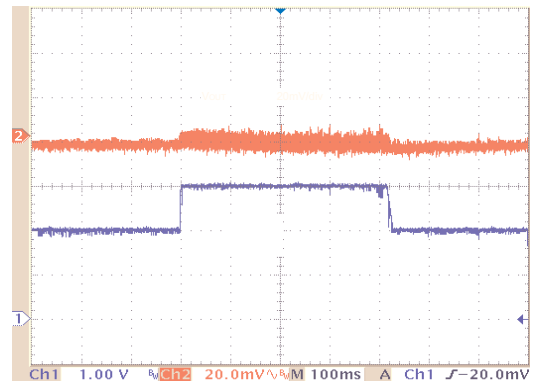
HT7750 Load Transient Response
($L=100\mu\text{H}$, $C_{\text{OUT}}=100\mu\text{F}$, $V_{\text{IN}}=3\text{V}$)



HT7733 Line Transient Response
($L=100\mu\text{H}$, $C_{\text{OUT}}=100\mu\text{F}$)



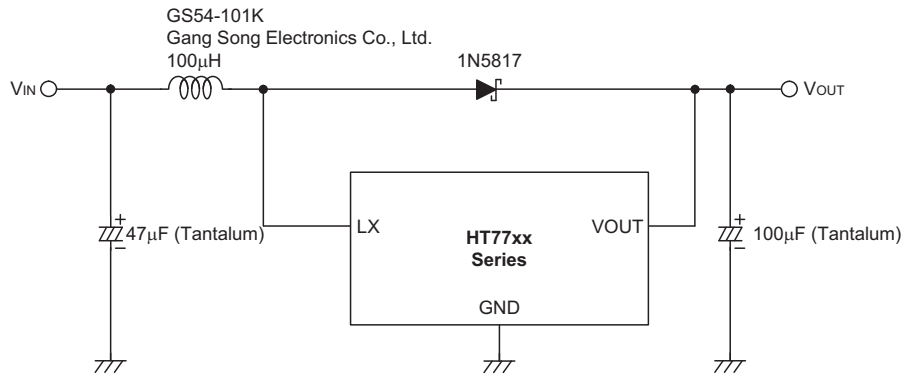
HT7722 Line Transient Response
($L=100\mu\text{H}$, $C_{\text{OUT}}=100\mu\text{F}$)



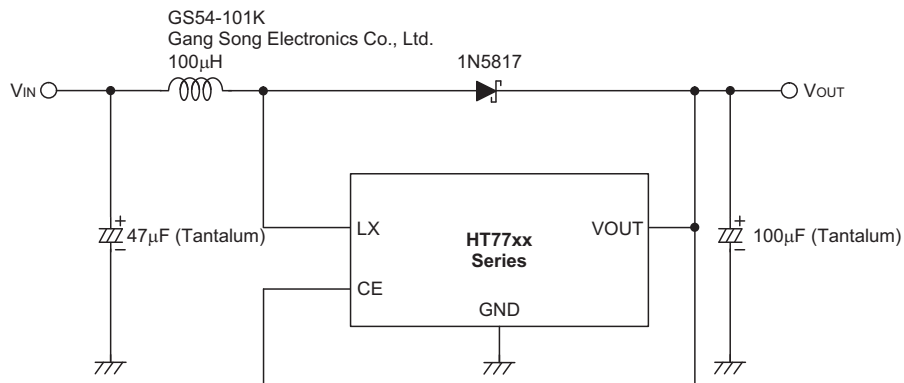
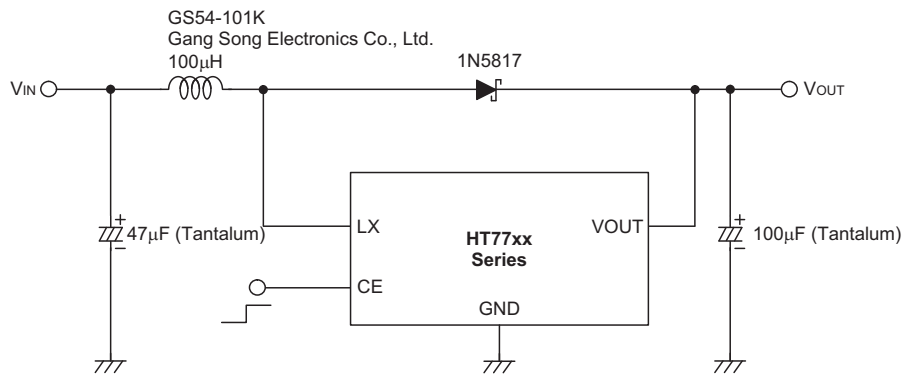
HT7750 Line Transient Response
($L=100\mu\text{H}$, $C_{\text{OUT}}=100\mu\text{F}$)

Application Circuits

Without CE Pin



With CE Pin



Note: For the SOT23-5 package, when CE is pulled low, the internal blocks of the device, such as the reference band gap, gain block, and all feedback and control circuitry will be switched off. The boost converter's output, V_{OUT}, will be at a value one Schottky diode voltage drop below the input voltage and the LX pin remains in a high impedance condition. The output capacitor and load at V_{OUT} determine the rate at which V_{OUT} decays.

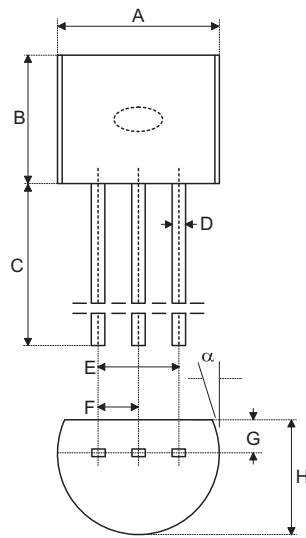
Package Information

Note that the package information provided here is for consultation purposes only. As this information may be updated at regular intervals users are reminded to consult the [Holtek website](#) for the latest version of the [Package/Carton Information](#).

Additional supplementary information with regard to packaging is listed below. Click on the relevant section to be transferred to the relevant website page.

- Package Information (include Outline Dimensions, Product Tape and Reel Specifications)
- The Operation Instruction of Packing Materials
- Carton information

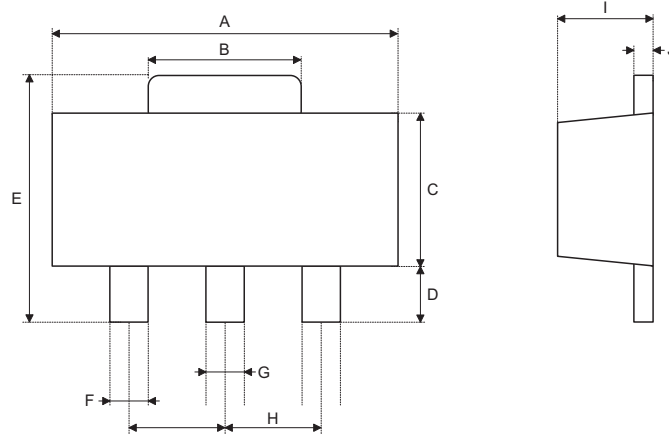
3-pin TO92 Outline Dimensions



Symbol	Dimensions in inch		
	Min.	Nom.	Max.
A	0.173	0.180	0.205
B	0.170	—	0.210
C	0.500	0.580	—
D	—	0.015 Typ	—
E	—	0.010 Typ	—
F	—	0.050 Typ	—
G	—	0.035 Typ	—
H	0.125	0.142	0.165

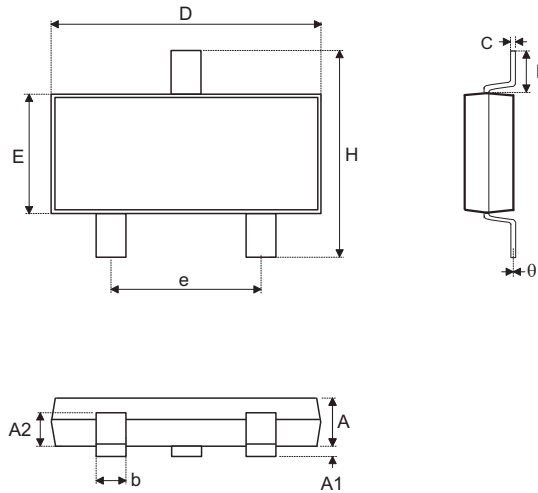
Symbol	Dimensions in mm		
	Min.	Nom.	Max.
A	4.39	4.57	5.21
B	4.32	—	5.33
C	12.70	14.73	—
D	—	0.38 Typ	—
E	—	2.54 Typ	—
F	—	1.27 Typ	—
G	—	0.89 Typ	—
H	3.18	3.61	4.19

3-pin SOT89 Outline Dimensions



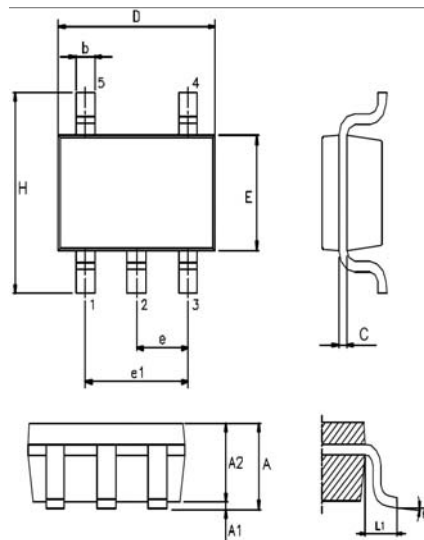
Symbol	Dimensions in inch		
	Min.	Nom.	Max.
A	0.173	—	0.181
B	0.053	—	0.072
C	0.090	—	0.102
D	0.035	—	0.047
E	0.155	—	0.167
F	0.014	—	0.019
G	0.017	—	0.022
H	—	0.059 BSC	—
I	0.055	—	0.063
J	0.014	—	0.017

Symbol	Dimensions in mm		
	Min.	Nom.	Max.
A	4.40	—	4.60
B	1.35	—	1.83
C	2.29	—	2.60
D	0.89	—	1.20
E	3.94	—	4.25
F	0.36	—	0.48
G	0.44	—	0.56
H	—	1.50 BSC	—
I	1.40	—	1.60
J	0.35	—	0.44

3-pin SOT23-3 Outline Dimensions


Symbol	Dimensions in inch		
	Min.	Nom.	Max.
A	—	—	0.057
A1	—	—	0.006
A2	0.035	0.045	0.051
b	0.012	—	0.020
C	0.003	—	0.009
D	—	0.114 BSC	—
E	—	0.063 BSC	—
e	—	0.037 BSC	—
H	—	0.075 BSC	—
L	—	0.110 BSC	—
L1	—	0.024 BSC	—
θ	0°	—	8°

Symbol	Dimensions in mm		
	Min.	Nom.	Max.
A	—	—	1.45
A1	—	—	0.15
A2	0.90	1.15	1.30
b	0.30	—	0.50
C	0.08	—	0.22
D	—	2.90 BSC	—
E	—	1.60 BSC	—
e	—	0.95 BSC	—
H	—	1.90 BSC	—
L	—	2.80 BSC	—
L1	—	0.60 BSC	—
θ	0°	—	8°

5-pin SOT23-5 Outline Dimensions


Symbol	Dimensions in inch		
	Min.	Nom.	Max.
A	—	—	0.057
A1	—	—	0.006
A2	0.035	0.045	0.051
b	0.012	—	0.020
C	0.003	—	0.009
D	—	0.114 BSC	—
E	—	0.063 BSC	—
e	—	0.037 BSC	—
H	—	0.075 BSC	—
L	—	0.110 BSC	—
L1	—	0.024 BSC	—
θ	0°	—	8°

Symbol	Dimensions in mm		
	Min.	Nom.	Max.
A	—	—	1.45
A1	—	—	0.15
A2	0.90	1.15	1.30
b	0.30	—	0.50
C	0.08	—	0.22
D	—	2.90 BSC	—
E	—	1.60 BSC	—
e	—	0.95 BSC	—
H	—	1.90 BSC	—
L	—	2.80 BSC	—
L1	—	0.60 BSC	—
θ	0°	—	8°

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